



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No. : 10/500,214 Confirmation No. : 2535
First Named Inventor : Takuya SUGAWARA, et al.
Filed : June 28, 2004
TC/A.U. : 2812
Examiner : To Be Assigned
Docket No. : 010986.55104US
Customer No. : 23911

Title : Substrate Treating Method and Production Method
for Semiconductor Device

REQUEST FOR CORRECTED OFFICIAL FILING RECEIPT

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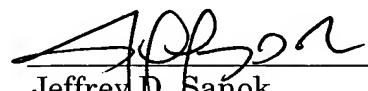
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Respectfully submitted,

May 20, 2005


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10/500,214	03/17/2005	2812	1050	010986.55104US	9	9	1

23911

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CONFIRMATION NO. 2535

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Applicant(s)

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Assignment For Published Patent Application

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Power of Attorney: The patent practitioners associated with Customer Number 23911.

Domestic Priority data as claimed by applicant

This application is a 371 of PCT/JP02/13550 12/25/2002

Foreign Applications

JAPAN 2001-394546 12/26/2001

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Non-Publication Request: No

Early Publication Request: No

Title

Substrate treating method and production method for semiconductor device

Preliminary Class

438

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